

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD disks::	
Number of Copies of CDs::	
Sequence Submission?::	None
Computer Readable Form (CRF)::	No
Number of copies of CRF::	0
Title::	MANUFACTURING METHOD OF SEMICONDUCTOR DEVICE AND OXIDIZATION METHOD OF SEMICONDUCTOR SUBSTRATE
Attorney Docket Number::	8040-1052
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	7
Small Entity?::	No
Latin Name::	
Variety Denomination Name::	
Petition Included?::	No
Petition Type::	
Licensed US Gov't Agency::	
Contract or Grant Numbers::	
Secrecy Order in Parent	No
Appl.?::	

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JAPAN
Status:: Full Capacity
Given Name:: TAISHI
Middle Name::
Family Name:: KUBOTA
City of Residence:: TOKYO
State or Province of
Residence::
Country of Residence:: JAPAN
Street of Mailing 2-1, YAESU 2-CHOME, CHUO-KU
Address::
City of Mailing Address:: TOKYO
State or Province of Mailing Address::
Country of Mailing Address:: JAPAN
Postal or Zip Code of Mailing Address::

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JAPAN
Status:: Full Capacity
Given Name:: YOSHIHIRO
Middle Name::
Family Name:: KITAMURA
City of Residence:: TOKYO
State or Province of
Residence::
Country of Residence:: JAPAN
Street of Mailing 2-1, YAESU 2-CHOME, CHUO-KU
Address::
City of Mailing Address:: TOKYO
State or Province of Mailing Address::
Country of Mailing Address:: JAPAN

Postal or Zip Code of Mailing Address::

Applicant Authority Type:: Inventor

Primary Citizenship Country:: JAPAN

Status:: Full Capacity

Given Name:: TAKUO

Middle Name::

Family Name:: OHASHI

City of Residence:: TOKYO

State or Province of
Residence::

Country of Residence:: JAPAN

Street of Mailing Address:: 2-1, YAESU 2-CHOME, CHUO-KU

City of Mailing Address:: TOKYO

State or Province of Mailing Address::

Country of Mailing Address:: JAPAN

Postal or Zip Code of Mailing Address::

Applicant Authority Type:: Inventor

Primary Citizenship Country:: JAPAN

Status:: Full Capacity

Given Name:: SUSUMU

Middle Name::

Family Name:: SAKURAI

City of Residence:: TOKYO

State or Province of
Residence::

Country of Residence:: JAPAN

Street of Mailing Address:: 2-1, YAESU 2-CHOME, CHUO-KU

City of Mailing Address:: TOKYO

State or Province of Mailing Address::

Country of Mailing Address:: JAPAN

Postal or Zip Code of Mailing Address::

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JAPAN
Status:: Full Capacity
Given Name:: TAKAYUKI
Middle Name::
Family Name:: KANDA
City of Residence:: TOKYO
State or Province of
Residence::
Country of Residence:: JAPAN
Street of Mailing Address:: 2-1, YAESU 2-CHOME, CHUO-KU

City of Mailing Address:: TOKYO
State or Province of Mailing Address::
Country of Mailing Address:: JAPAN
Postal or Zip Code of Mailing Address::

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JAPAN
Status:: Full Capacity
Given Name:: SHINICHI
Middle Name::
Family Name:: HORIBE
City of Residence:: TOKYO
State or Province of
Residence::
Country of Residence:: JAPAN
Street of Mailing Address:: 2-1, YAESU 2-CHOME, CHUO-KU

City of Mailing Address:: TOKYO
State or Province of Mailing Address::
Country of Mailing Address:: JAPAN

Postal or Zip Code of Mailing Address::

Correspondence Information

Correspondence Customer 000466

Number::

Representative Information

Representative Customer	000466
Number::	

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2003-16968	1/27/03	Yes

Assignment Information

Assignee Name::

Street of Mailing Address::

City of Mailing Address::

State or Province of Mailing Address::

Country of Mailing Address::

Postal or Zip Code of Mailing Address::